

Customer No.: 31561
Docket No.: 11209-US-PA
Application No.: 10/605,326

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APR 04 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

YEH, Gang-Yu et al.

Serial No.: 10/605,326

Filed: 09/23/2003

For: Method Of Forming Emiconductor Device
With Non-conformal Liner Layer That is
Thinner On Sidewall Surfaces

Examiner: SMOOT, Stephen W

Art Unit: 2813

Docket No.: 11209-US-PA

No fee is believed to be due in connection with this amendment and response to Office Action. If, however, any fee is believed to be due, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (order No. 11209-US-PA).

AMENDMENT AFTER FINAL AND RESPONSE

United States Patent and Trademark Office
Customer Service Window
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Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

The Office Action dated 02/07/2005, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

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